



## AON4420L

**General Description** 

# N-Channel Enhancement Mode Field Effect Transistor

# The AON4420L combines advanced trench MOSFET technology with a small footprint package to provide low $R_{\mathrm{DS}(\mathrm{ON})}$ per unit area. This device is ideal for load switch and high speed switching applications.

### **Features**

 $V_{DS}(V) = 30V$ 

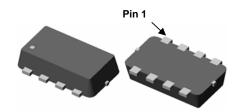
 $I_{D} = 10A$   $(V_{GS} = 10V)$ 

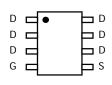
 $R_{DS(ON)} < 19m\Omega$  (V<sub>GS</sub> = 10V)

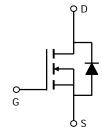
 $R_{DS(ON)}$  < 25m $\Omega$  (V<sub>GS</sub> = 4.5V)

- RoHS Compliant
- Halogen Free









| Absolute Maximum Ratings T <sub>A</sub> =25°C unless otherwise noted |                      |                 |            |       |  |  |  |  |  |
|--|----------------------|-----------------|------------|-------|--|--|--|--|--|
| Parameter  |                      | Symbol          | Maximum    | Units |  |  |  |  |  |
| Drain-Source Voltage   |                      | $V_{DS}$        | 30         | V     |  |  |  |  |  |
| Gate-Source Voltage  |                      | $V_{GS}$        | ±20        | V     |  |  |  |  |  |
| Pulsed Drain Current <sup>C</sup>                                    |                      | I <sub>DM</sub> | 50         |       |  |  |  |  |  |
| Continuous Drain   | T <sub>A</sub> =25°C |                 | 10         | ۸     |  |  |  |  |  |
| Current <sup>A</sup>   | T <sub>A</sub> =70°C | I <sub>D</sub>  | 8          | 7 A   |  |  |  |  |  |
|  | T <sub>A</sub> =25°C | $-P_D$          | 1.6        | W     |  |  |  |  |  |
| Power Dissipation A  | T <sub>A</sub> =70°C |                 | 1          | ¬     |  |  |  |  |  |
| Junction and Storage Temperature Range                               |                      | $T_J, T_{STG}$  | -55 to 150 | °C    |  |  |  |  |  |

| Thermal Characteristics                    |              |                                   |     |       |      |  |  |  |  |
|--|--------------|-----------------------------------|-----|-------|------|--|--|--|--|
| Parameter                                  | Symbol       | Тур                               | Max | Units |      |  |  |  |  |
| Maximum Junction-to-Ambient A              | t ≤ 10s      | $R_{\scriptscriptstyle{	hetaJA}}$ | 34  | 40    | °C/W |  |  |  |  |
| Maximum Junction-to-Ambient A Steady-State |              | Т∖θЈА                             | 66  | 80    | °C/W |  |  |  |  |
| Maximum Junction-to-Lead <sup>B</sup>      | Steady-State | $R_{	heta JL}$                    | 20  | 25    | °C/W |  |  |  |  |

#### Electrical Characteristics (T<sub>J</sub>=25°C unless otherwise noted)

| Symbol                | Parameter                             | Conditions  | Min | Тур  | Max  | Units |  |  |  |  |
|-----------------------|---------------------------------------|---|-----|------|------|-------|--|--|--|--|
| STATIC PARAMETERS     |                                       |   |     |      |      |       |  |  |  |  |
| BV <sub>DSS</sub>     | Drain-Source Breakdown Voltage        | $I_D = 250 \mu A, V_{GS} = 0V$                                  | 30  |      |      | V     |  |  |  |  |
| I <sub>DSS</sub>      | Zero Gate Voltage Drain Current       | V <sub>DS</sub> = 30V, V <sub>GS</sub> = 0V                     |     |      | 1    | μА    |  |  |  |  |
| .D22                  |                                       | T <sub>J</sub> = 55°C   |     |      | 5    | μΛ    |  |  |  |  |
| $I_{GSS}$             | Gate-Body leakage current             | $V_{DS} = 0V, V_{GS} = \pm 20V$                                 |     |      | ±100 | nA    |  |  |  |  |
| $V_{GS(th)}$          | Gate Threshold Voltage                | $V_{DS} = V_{GS} I_D = 250 \mu A$                               | 1.4 | 1.9  | 2.5  | V     |  |  |  |  |
| $I_{D(ON)}$           | On state drain current                | $V_{GS} = 10V, V_{DS} = 5V$                                     | 50  |      |      | Α     |  |  |  |  |
| R <sub>DS(ON)</sub>   | Static Drain-Source On-Resistance     | V <sub>GS</sub> = 10V, I <sub>D</sub> = 10A                     |     | 16   | 20   |       |  |  |  |  |
|                       |                                       | T <sub>J</sub> =125°C   |     | 27   |      | mΩ    |  |  |  |  |
|                       |                                       | $V_{GS} = 4.5V, I_D = 8A$                                       |     | 21   | 26   |       |  |  |  |  |
| <b>g</b> FS           | Forward Transconductance              | $V_{DS} = 5V, I_{D} = 10A$                                      |     | 30   |      | S     |  |  |  |  |
| $V_{SD}$              | Diode Forward Voltage                 | $I_S = 1A, V_{GS} = 0V$   |     | 0.75 | 1    | V     |  |  |  |  |
| I <sub>S</sub>        | Maximum Body-Diode Continuous Current |   |     |      | 3    | Α     |  |  |  |  |
| DYNAMIC               | PARAMETERS                            |   |     |      |      |       |  |  |  |  |
| C <sub>iss</sub>      | Input Capacitance                     |   | 440 | 550  | 660  | рF    |  |  |  |  |
| C <sub>oss</sub>      | Output Capacitance                    | $V_{GS}$ =0V, $V_{DS}$ =15V, f=1MHz                             | 80  | 110  | 140  | рF    |  |  |  |  |
| C <sub>rss</sub>      | Reverse Transfer Capacitance          |   | 35  | 55   | 80   | рF    |  |  |  |  |
| $R_g$                 | Gate resistance                       | V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, f=1MHz                | 2   | 4    | 6    | Ω     |  |  |  |  |
| SWITCHI               | NG PARAMETERS                         |   |     |      |      |       |  |  |  |  |
| Q <sub>g</sub> (10V)  | Total Gate Charge (10V)               |   | 8   | 9.8  | 12   | nC    |  |  |  |  |
| Q <sub>g</sub> (4.5V) | Total Gate Charge (4.5V)              | V <sub>GS</sub> =10V, V <sub>DS</sub> =15V, I <sub>D</sub> =10A | 4   | 4.6  | 5.5  | nC    |  |  |  |  |
| $Q_{gs}$              | Gate Source Charge                    | V <sub>GS</sub> -10V, V <sub>DS</sub> -13V, I <sub>D</sub> -10A | 1.5 | 1.8  | 2.2  | nC    |  |  |  |  |
| $Q_{gd}$              | Gate Drain Charge                     | ] [   | 1.3 | 2.2  | 3    | nC    |  |  |  |  |
| t <sub>D(on)</sub>    | Turn-On DelayTime                     |   |     | 5    |      | ns    |  |  |  |  |
| t <sub>r</sub>        | Turn-On Rise Time                     | $V_{GS}$ =10V, $V_{DS}$ =15V, $R_{L}$ =1.5 $\Omega$ ,           |     | 3.2  |      | ns    |  |  |  |  |
| $t_{D(off)}$          | Turn-Off DelayTime                    | $R_{GEN}$ =3 $\Omega$   |     | 24   |      | ns    |  |  |  |  |
| t <sub>f</sub>        | Turn-Off Fall Time                    | ] [   |     | 6    |      | ns    |  |  |  |  |
| t <sub>rr</sub>       | Body Diode Reverse Recovery Time      | I <sub>F</sub> =10A, dI/dt=300A/μs                              | 8   | 11   | 14   | ns    |  |  |  |  |
| $Q_{rr}$              | Body Diode Reverse Recovery Charge    | I <sub>F</sub> =10A, dI/dt=300A/μs                              | 11  | 13   | 16   | nC    |  |  |  |  |

A: The value of R  $_{0,JA}$  is measured with the device mounted on  $1\text{in}^2$  FR-4 board with 2oz. Copper, in a still air environment with  $T_A$  = 25°C. The value in any given application depends on the user's specific board design.

Rev0: July 2008

THIS PRODUCT HAS BEEN DESIGNED AND QUALIFIED FOR THE CONSUMER MARKET. APPLICATIONS OR USES AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS ARE NOT AUTHORIZED. AOS DOES NOT ASSUME ANY LIABILITY ARISING OUT OF SUCH APPLICATIONS OR USES OF ITS PRODUCTS. AOS RESERVES THE RIGHT TO IMPROVE PRODUCT DESIGN, FUNCTIONS AND RELIABILITY WITHOUT NOTICE.

B: Repetitive rating, pulse width limited by junction temperature.

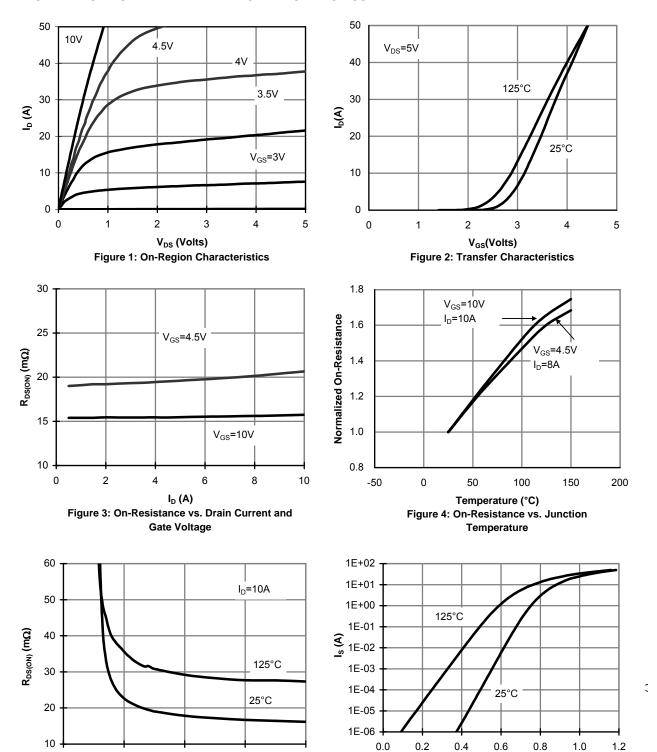
C. The R  $_{\theta JA}$  is the sum of the thermal impedence from junction to lead R  $_{\theta JL}$  and lead to ambient.

D. The static characteristics in Figures 1 to 6 are obtained using  $t \le 300 \mu s$  pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in  $^2$  FR-4 board with 2oz. Copper, in a still air environment with  $T_A$ =25°C. The SOA curve provides a single pulse rating.

F. The current rating is based on the  $t \leqslant 10 s$  thermal resistance rating.

#### TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



 $\label{eq:VGS} V_{GS} \, \mbox{(Volts)}$  Figure 5: On-Resistance vs. Gate-Source Voltage

6

8

10

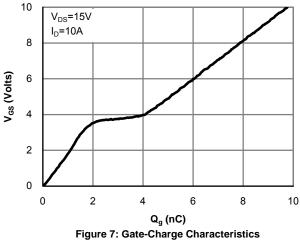
V<sub>SD</sub> (Volts)

Figure 6: Body-Diode Characteristics

4

2

#### TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



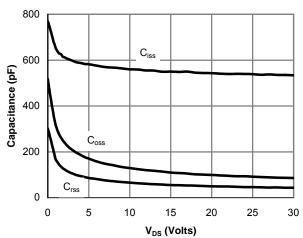


Figure 8: Capacitance Characteristics

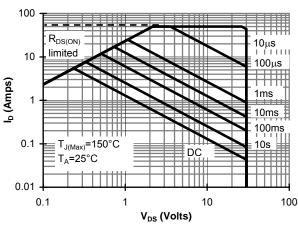


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

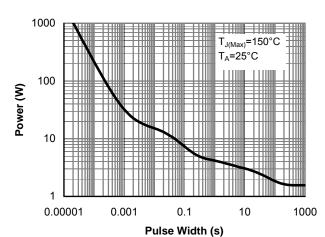


Figure 10: Single Pulse Power Rating Junctionto-Ambient (Note E)

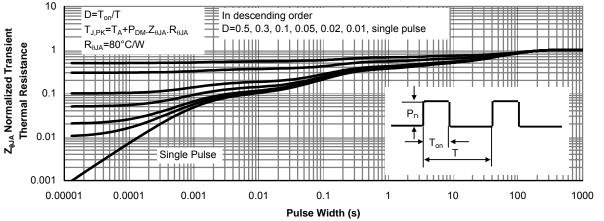
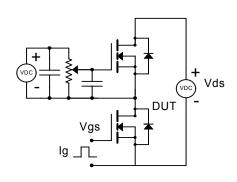
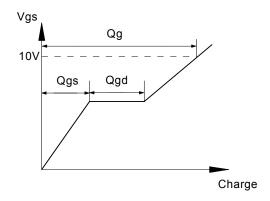


Figure 11: Normalized Maximum Transient Thermal Impedance(Note E)

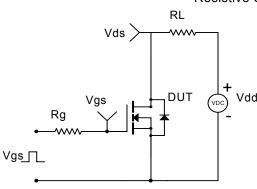
Ć

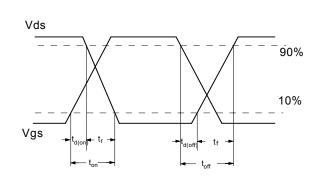
## Gate Charge Test Circuit & Waveform



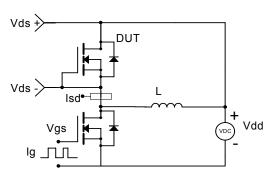


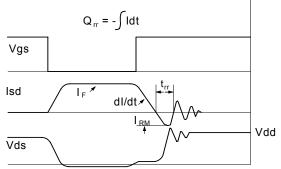
# Resistive Switching Test Circuit & Waveforms





# Diode Recovery Test Circuit & Waveforms





# 单击下面可查看定价,库存,交付和生命周期等信息

# >>AOS(万代)